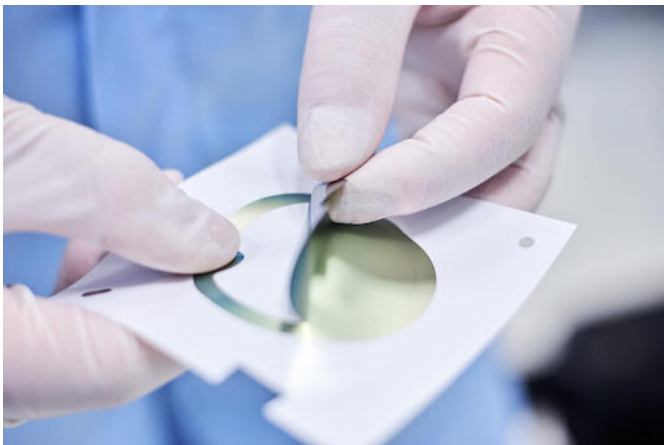


Ultra-thin Adhesive Technologies - Contract Manufacturing



We aim to stay a step ahead when developing products. We focus on developing Ultra-Thin Foils and Seals for the Semiconductor, Medical and Electronics industries.

For our Contract Manufacturing customers we use our bonding and adhesive knowledge to assemble Mechanical Sub Assemblies and apply Surface Treatments (such as PECVD).



The best Co-Creation efforts are targeted and specific. We understand the challenges that our customers face.

Our products can be found in the most advanced Lithography Scanners and Optical equipment.

So, do you need a solution for a high-tech product or in high tech manufacturing? Our R&D team can't wait to co-create your new solution with you.